IPC ASSOCIATION CONNE	© Copyright 2005.	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.			der both	This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lower level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.								
752-21.1		IPC Web Site for Information on IPC-1752 Standard  http://www.ipc.org/IPC-175x  Form Tyl Distribute				e * Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materi				ials and Mfg Information				
Supplier Info	ormation													
Company name*			Company unique ID			Ţ	Unique ID Authority				Response Date*			
On Semiconductor											2021-02-04			
Contact Name			Title - Contact			I	Phone - Contact*				Email - Contact*			
Product-Env-Stewards			Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com			
Authorized Representative*			Title - Representative			I	Phone - Representative*			Email - Representative*				
Product-Env-Stewards			Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com			
Requ	ester Item Number	Mfr Item Number		Mfr Item Name  10 A 100V Schottky			Effective Date	Version	ersion Manufacturing Site		W	eight*	UOM	Unit Type
		FSV10100V 10					2021-02-04 PANJITFG		ANJITFG	92	.0	mg	Each	
T	ng Process Informa		Comminal Dago	Allow	STD-020 MS	I. Dating	Dools Droo	ass Dady T		Mov Time at Deals	Tommorotum	a Numi	ber of Reflow Cyc	laa
		Terminal Base Alloy J-STI CU Alloy 1		STD-020 MS	L Kanng	Peak Process Body Tempo 260 C		T *				ber of Reflow Cyc	ies	
•	z 1111 (511) - anneaied		O Alloy	1			200		IC	Ju	seconds	J		
omments	ım time at peak temperat	ure during sel	doring is 10-3	A seconds										
	nn time at peak temperat nation regarding materia													

RoHS Material Composition Declaration			Declaration Type *	Detailed						
Priective 2015/863/EU amending RoHS Directive 2011/65/EU  RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).										
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledges that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier enter into a written agreement with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies of Supplier's Standard Terms and Conditions of Sale applicable to such part shall apply.										
RoHS Declaration * 4 - Item(s	) does not contain RoHS restricted substance	s per the definition above except for selected exemp	tions Supplier Acceptance	* Accepted						
Exemption: 7a: Lead in high melting temperature type solders (i.e. lead based solder alloys containing 85% by weight or more lead).										
Exemption List Version	EL-2011/534/EU									
Declaration Signature										
Instructions: Complete all of the required fields on all pages of this form. Select the "Accepted" on the Supplier Acceptance drop-down. This will display the signature area. Digitally sign the declaration (if required by the Requester) and click on Submit Form to have the form returned to the Requester.										
Supplier Digital Signature Ra	astislav Drska	-En								

## **Homogeneous Material Composition Declaration for Electronic Products**

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Clip	4.942	mg	Supplier	Iron (Fe)	7439-89-6		0.1483	mg
			Supplier	Copper (Cu)	7440-50-8		4.7937	mg
Die	9.594	mg	Supplier	Silicon (Si)	7440-21-3		9.594	mg
Die Attach Solder	4.165		Supplier	Silver (Ag)	7440-22-4		0.1041	mg
			A	Lead (Pb)	7439-92-1	7a	3.8526	mg
			Supplier	Tin (Sn)	7440-31-5		0.2083	mg
Lead Frame	30.081	mg	Supplier	Iron (Fe)	7439-89-6		0.045	mg
			Supplier	Copper (Cu)	7440-50-8		30.021	mg
			Supplier	Phosphorus (P)	7723-14-0		0.015	mg
Mold Compound-Black	43.217		Supplier	Ortho Cresol Novolac Resin	29690-82-2		4.3217	mg
			Supplier	Carbon Black (C)	1333-86-4		0.1297	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		34.4439	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		4.3217	mg
Plating	0.001	mg	Supplier	Tin (Sn)	7440-31-5		0.001	mg